



# Product Change Notification

**Change Notification #:** 115738 - 00  
**Change Title:** Select Intel® SSD DC P4510 Series Products, PCN 115738-00, Product Design, Label, Firmware Change and Change to ROHS LOGO on Label  
**Date of Publication:** August 14, 2017

## Key Characteristics of the Change:

Product Design, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Sep 11, 2017
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## Description of Change to the Customer:

The Intel® SSD DC P4510 SKUs listed in the products affected table below will have the following changes.

1. The Intel® SSD DC P4510 Series firmware version is being updated from VDV10100 to VDV10110. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.
2. The label will be updated to include a new ROHS marking. See example pictures below.

Current

**INTEL® SSD XX XXXXX SERIES XXXGB**

VDC AMPS  
+X.XV X.XA  
+X.XV X.XA  
FW: XXXXXXXX






PCI EXPRESS®  
nvm EXPRESS®




Intel Corporation  
Attn: Corporate Quality  
2200 Mission College Blvd.  
Santa Clara, CA 95054-1549, USA


SA: XXXXXX-XXX  
PBA: XXXXXX-XXX  
LBA XXX,XXX,XXX  
Pb-free 2LI  
CAN ICES-3(A)/NMB-3(A) / WO: Xs  
Model: SSDXXXXXXXXXX  
2.5" NVMe/PCIe SSD XXXG

WWN: XXXXXXXXXXXXXXXX  
DUID  
XXXXXXXXXX  
XXXXXXXXXX  
XXXXXXXXXX  
XXXXXXXXXX

WARRANTY VOID IF ANY LABEL/  
SCREW IS REMOVED OR BROKEN  
Designed in USA, assembled in Xxxxx.



Future

**INTEL® SSD XX XXXXX SERIES XXXGB**

VDC AMPS  
+X.XV X.XA  
+X.XV X.XA  
FW: XXXXXXXX






PCI EXPRESS®  
nvm EXPRESS®




Intel Corporation  
Attn: Corporate Quality  
2200 Mission College Blvd.  
Santa Clara, CA 95054-1549, USA


SA: XXXXXX-XXX  
PBA: XXXXXX-XXX  
LBA XXX,XXX,XXX  
Pb-free 2LI  
CAN ICES-3(A)/NMB-3(A) / WO: Xs  
Model: SSDXXXXXXXXXX  
2.5" NVMe/PCIe SSD XXXG

WWN: XXXXXXXXXXXXXXXX  
DUID  
XXXXXXXXXX  
XXXXXXXXXX  
XXXXXXXXXX  
XXXXXXXXXX

WARRANTY VOID IF ANY LABEL/  
SCREW IS REMOVED OR BROKEN  
Designed in USA, assembled in Xxxxx.



## Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

The change to the label for the ROHS LOGO does not affect the Form, Fit or Function of the product. Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX010T801	959391	J65287-100	J65296-100	J65287-101	J65296-101
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX010T810	959392	J65288-100	J65296-100	J65288-101	J65296-101
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX020T801	959393	J65291-001	J65298-001	J65291-002	J65298-002
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX020T810	959394	J65292-001	J65298-001	J65292-002	J65298-002

## PCN Revision History:

**Date of Revision:**

August 14, 2017

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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